Claims

What is claimed is:

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- 5 1. A head-stage for implanting as a tissue interface, comprising:
 - a first connector coupled for receiving a plurality of electrical signals;
 - a flexible substrate coupled to the first connector and including a plurality of conductors for the electrical signals;
 - a stiffener substrate coupled to a portion of the flexible substrate;

an electronic circuit disposed on the flexible substrate above the stiffener substrate and having inputs coupled to the plurality of conductors; and

- a second connector supported by the stiffener substrate and coupled to an output of the electronic circuit.
- 2. The head-stage of claim 1 wherein the flexible substrate includes benzocyclobutene.
 - 3. The head-stage of claim 1 wherein the flexible substrate includes polyimide.
- 4. The head-stage of claim 1 wherein the flexible substrate overlies a portion of the stiffener substrate.
 - 5. The head-stage of claim 1 wherein the electronic circuit performs signal processing on the electrical signals.
 - 6. The head-stage of claim 1 wherein the flexible substrate and stiffener substrate are implanted under a skin surface of a test subject.

- 7. The head-stage of claim 1 wherein the second connector is a zero insertion force type connector.
- 8. A head-stage, comprising:

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- a flexible substrate including a conductor for conducting
 an electrical signal;
 - a stiffener substrate coupled to a first end of the flexible substrate;

an electronic circuit supported by the stiffener substrate and having an input coupled to the conductor; and

an external interface coupled to an output of the electronic circuit and supported by the stiffener substrate for transmitting the electrical signal.

- 9. The head-stage of claim 8 wherein the flexible substrate includes benzocyclobutene.
 - 10. The head-stage of claim 8 wherein the external interface includes a first connector supported by the stiffener substrate and coupled to an output of the electronic circuit.
 - 11. The head-stage of claim 10 wherein the first connector is a zero insertion force type connector.
- 25 12. The head-stage of claim 10 further including a second connector coupled to a second end of the flexible substrate.
 - 13. The head-stage of claim 8 wherein the flexible substrate overlies a portion of the stiffener substrate.
 - 14. The head-stage of claim 8 wherein the flexible substrate and stiffener portion are implanted under a skin surface of a test subject.

- 15. The head-stage of claim 8 wherein the electronic circuit conducts the electrical signal bi-directionally along the conductor.
- 5 16. An integrated head-stage, comprising:

an integrated substrate having a first portion forming an electrode for implanting into live tissue and a second portion forming a flexible substrate and including a conductor for conducting an electrical signal;

a stiffener substrate coupled to an end of the flexible substrate opposite the electrode; and

an external interface supported by the stiffener substrate for transmitting the electrical signal.

- 17. The integrated head-stage of claim 16 wherein the external interface includes an electronic circuit disposed above the stiffener substrate and having an input coupled to the conductor.
- 18. The integrated head-stage of claim 17 wherein the external interface further includes a first connector supported by the stiffener substrate and coupled to an output of the electronic circuit.
- 25 19. The integrated head-stage of claim 18 wherein the first connector is a zero insertion force type connector.

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- 20. The integrated head-stage of claim 16 wherein the electrode and flexible substrate include benzocyclobutene.
- 21. The integrated head-stage of claim 16 wherein the flexible substrate overlies a portion of the stiffener substrate.

- 22. A head-stage for implanting as a tissue interface, comprising:
- a flexible substrate including a conductor for conducting an electrical signal;
- a stiffener substrate coupled to the flexible substrate; and

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an external interface supported by the stiffener substrate for transmitting the electrical signal.

- 10 23. The head-stage of claim 22 wherein the flexible substrate includes benzocyclobutene.
 - 24. The head-stage of claim 22 wherein the external interface includes an electronic circuit disposed above the stiffener substrate and having an input coupled to the conductor.
 - 25. The head-stage of claim 24 wherein the external interface further includes a first connector supported by the stiffener substrate and coupled to an output of the electronic circuit.
 - 26. The head-stage of claim 25 wherein the first connector is a zero insertion force type connector.
- 27. The head-stage of claim 22 wherein the electronic circuit conducts the electrical signal bi-directionally along the conductor.